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GR 97 P 1903

BOX AF

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By: 

Date: April 5, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 09/483,737 Confirmation No. 8769  
Applicant : Hansjörg Reichert et al.  
Filed : January 14, 2000  
TC/A.U. : 2826  
Examiner : Ahmed N Sefer  
Title: : Method and Apparatus for Producing a Chip-Substrate Connection

Docket No. : GR 97 P 1903

Customer No. : 24131

BOX AF

Hon. Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT under 37 C.F.R. § 1.116**

S i r :

In response to the final Office action dated January 7, 2004,  
please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of  
claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.